

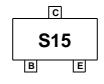
July 2007

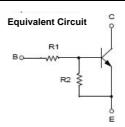
# FJY3015R NPN Epitaxial Silicon Transistor

## **Features**

- · Switching circuit, Inverter, Interface circuit, Driver Circuit
- Built in bias Resistor (R1=2.2KΩ, R2=10KΩ)







# Absolute Maximum Ratings \* T<sub>a</sub> = 25°C unless otherwise noted

Symbol	Parameter	Value	Units
V <sub>CBO</sub>	Collector-Base Voltage	50	V
V <sub>CEO</sub>	Collector-Emitter Voltage	50	V
V <sub>EBO</sub>	Emitter-Base Voltage	10	V
I <sub>C</sub>	Collector Current	100	mA
T <sub>STG</sub>	Storage Temperature Range	-55~150	°C
T <sub>J</sub>	Junction Temperature	150	°C
P <sub>C</sub>	Collector Power Dissipation, by R <sub>θJA</sub>	N/A	mW

<sup>\*</sup> These ratings are limiting values above which the serviceability of any semiconductor device may by impaired.

# Thermal Characteristics\* Ta=25°C unless otherwise noted

Symbol	Parameter	Max	Units
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	N/A	°C/W
* Minimum land pad.			

# Electrical Characteristics\* T<sub>C</sub> = 25°C unless otherwise noted

Symbol	Parameter	Test Condition	MIN	Тур	MAX	Units
V <sub>(BR)</sub> CBO	Collector-Emitter Breakdown Voltage	Ic = 10 uA, IE = 0	50			V
V <sub>(BR)</sub> CEO	Collector-Base Breakdown Voltage	Ic = 100 uA, I <sub>B</sub> = 0	50			V
Ісво	Collector-Cutoff Current	Vcb = 40 V, IE = 0			0.1	uA
hfe	DC Current Gain	VcE = 5 V, Ic = 10 mA	33			
Vce(sat)	Collector-Emitter Saturation Voltage	Ic = 10 mA, I <sub>B</sub> = 0.5 mA			0.3	V
f⊤	Current Gain - Bandwidth Product	Vce = 10V, Ic = 5 mA		250		MHz
Ccb	Output Capacitance	Vcb = 10 V, IE = 0, f = 1.0 MHz		3.7		pF
Vı(off)	Input Off Voltage	VcE = 5 V, Ic = 100uA	0.3			V
V <sub>I</sub> (on)	Input On Voltage	VcE = 0.3V, Ic = 20mA			3	V
R <sub>1</sub>	Input Resistor		1.5	2.2	2.9	ΚΩ
R <sub>1</sub> /R <sub>2</sub>	Resistor Ratio		0.20	0.22	0.25	

<sup>\*</sup> Pulse Test: PW≤300μs, Duty Cycle≤2%

# **Typical Performance Characteristics**

Figure 1. DC current Gain

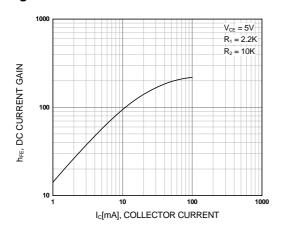


Figure 2. Input On Voltage

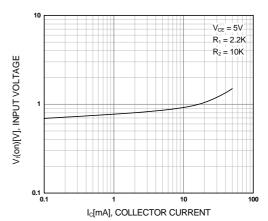


Figure 3. Input off Voltage

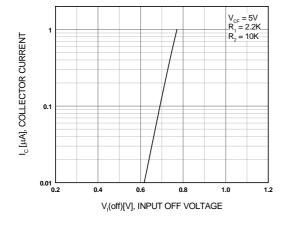
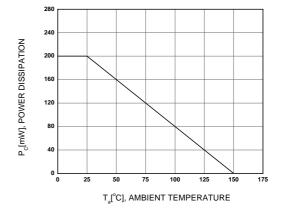
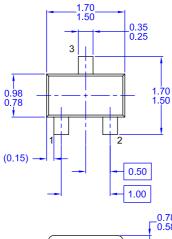


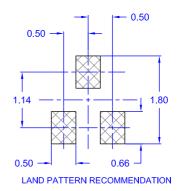
Figure 4. Power Derating

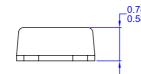


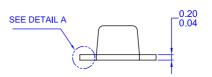
# **Package Dimensions**

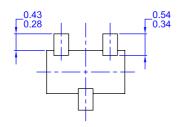
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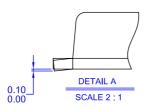












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- B) ALL DIMENSIONS ARE IN MILLIMETERS.
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Dimensions in Millimeters





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Rev. I25